TIDA-00816 Block Diagram

Power for LaunchXL-CC1310

Power Supply → TPS79601 → 3.3V

Sub 1 GHz Communication between Fault Indicator and Data Collector

Fault Indicator Nodes (1)
Fault Indicator Nodes (2)
Fault Indicator Nodes (n)
CC1310 (Arm + Sub-1 GHz)

Data Collector
CC1310 (Arm + Sub-1 GHz)
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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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